

# AIDA-2020

Advanced European Infrastructures for Detectors at Accelerators

## Presentation

# The MPGD-Based Photon Detectors for the upgrade of COMPASS RICH-1 and beyond

Dalla Torre, S. (INFN Trieste (on behalf of the COMPASS RICH  
group))

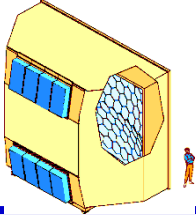
01 June 2018



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This work is part of AIDA-2020 Work Package **13: Innovative gas detectors**.

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***The MPGD-Based Photon Detectors  
for the upgrade of COMPASS RICH-1  
and beyond***

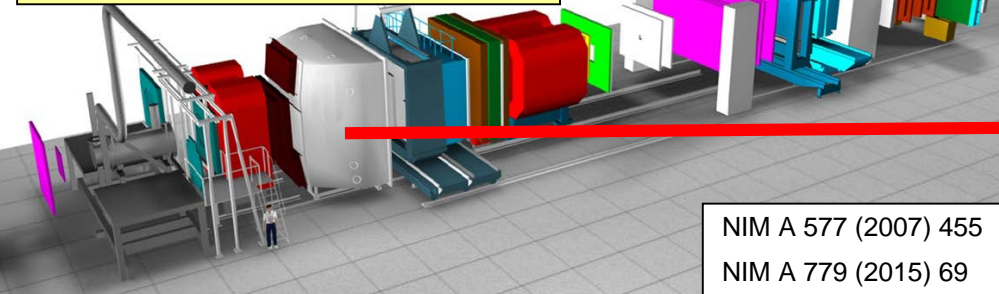
***S. Dalla Torre***

***INFN - TRIESTE***

on behalf of the COMPASS RICH group

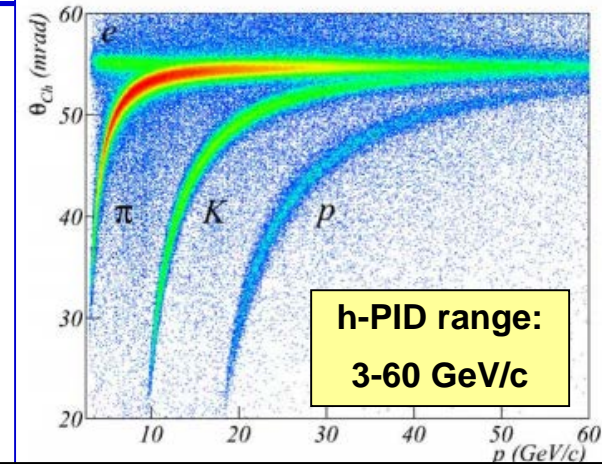
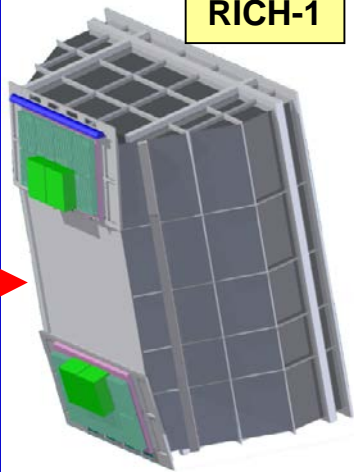
# COMPASS RICH-1

**COMPASS Spectrometer  
dedicated to h physics  
@ SPS (CERN)**



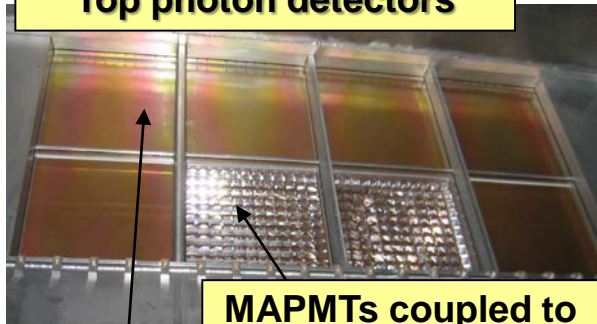
NIM A 577 (2007) 455  
NIM A 779 (2015) 69

**RICH-1**



NIM A 553 (2005) 215; NIM A(2008) 371; NIM A(616) (2010) 21; NIM A 631 (2011) 26

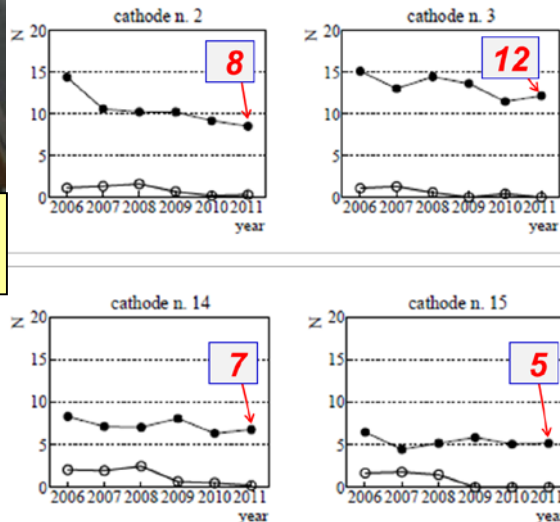
**Top photon detectors**



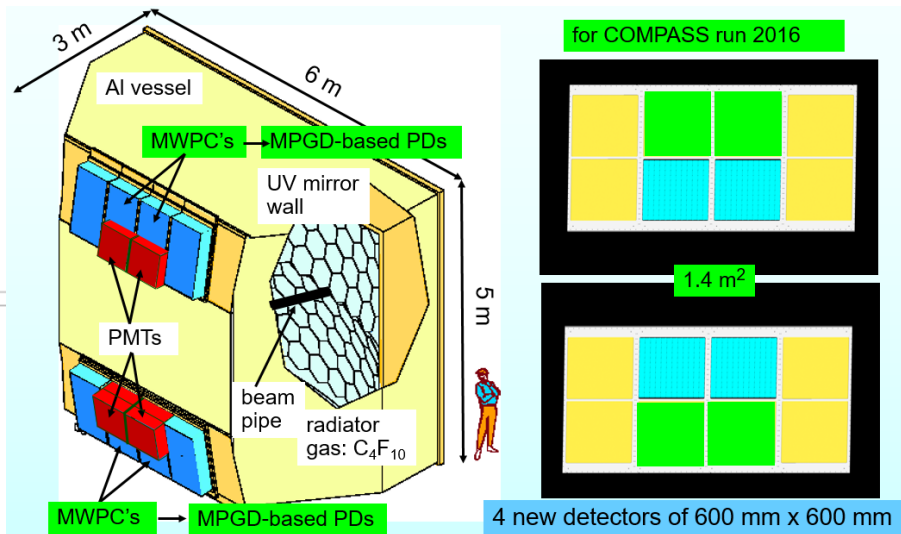
**MAPMTs coupled to  
lens telescopes**

**MWPCs+CsI (from RD26):  
successful but performance  
limitations, in particular for  
the 4 central chambers**

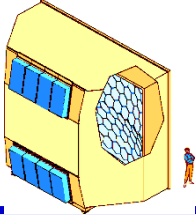
**n. of ph.s @  $\beta = 1$**



JINST 9 (2014) P01006

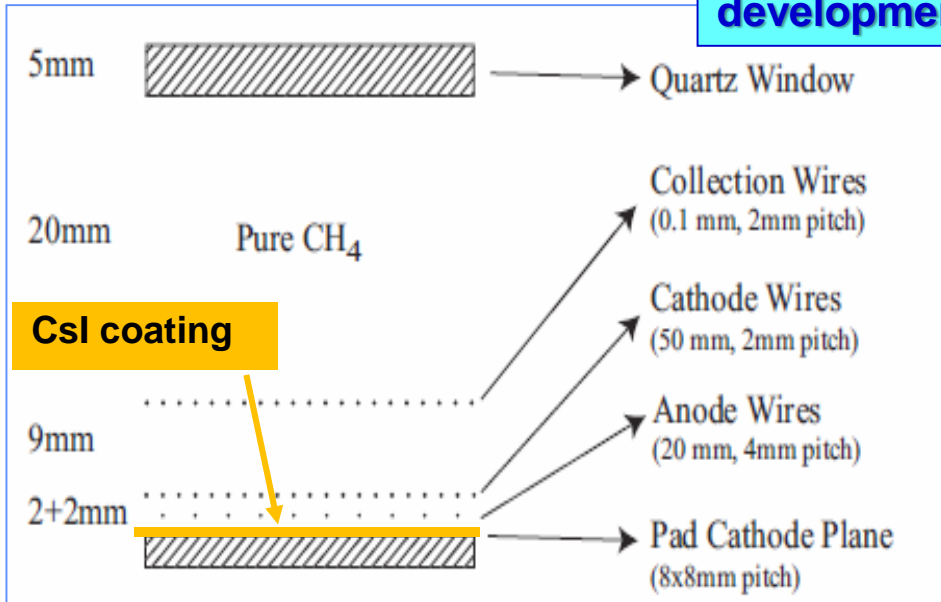


# PHOTON DETECTORS so far



## MWPCs + CsI

## RD26 development



## Reduced wire-cathode gap because of :

- Fast RICH (fast ion collection)
- Reduced MIP signal
- Reduced cluster size
- Control photon feedback spread

## MWPCs with CsI photocathode, the limitations

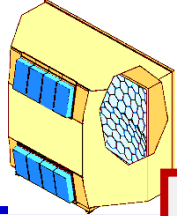
- Severe recovery time ( $\sim 1$  d) after a detector discharge
    - Ion accumulation at the photocathode
  - Feedback pulses
    - Ion and photons feedback from the multiplication process
  - Ageing (QE reduction) after integrating a few  $mC / cm^2$ 
    - Ion bombardment of the photocathode
- Low gain: a few times  $10^4$  (effective gain:  $< 1/2$ )
- "slow" detector

## To overcome the limitations:

- Less critical architecture
- suppress the PHOTON & ION feedback
- use intrinsically faster detectors

→ **MPGDs**





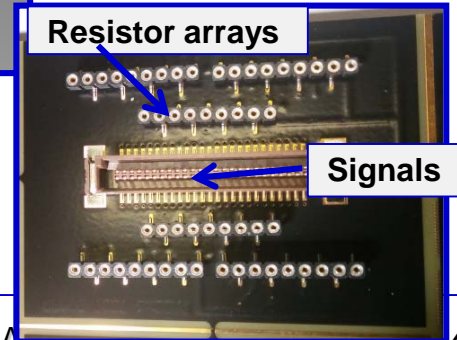
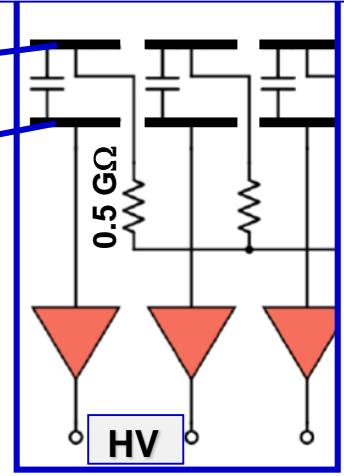
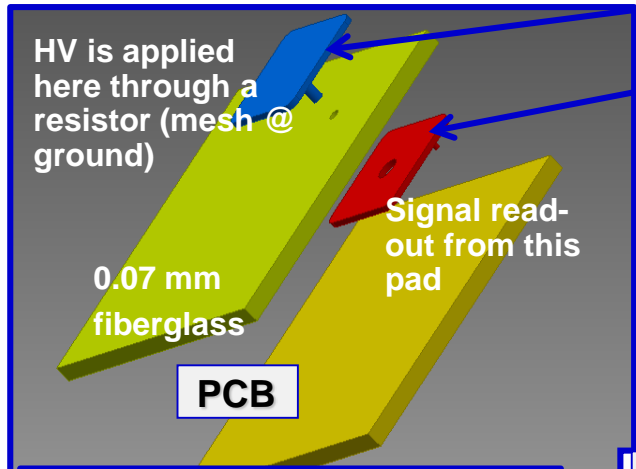
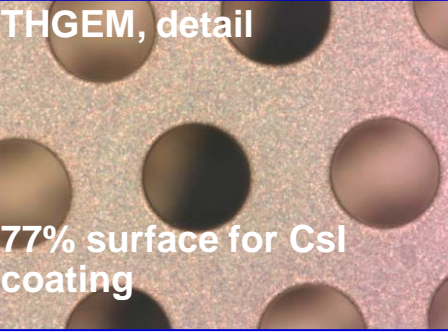
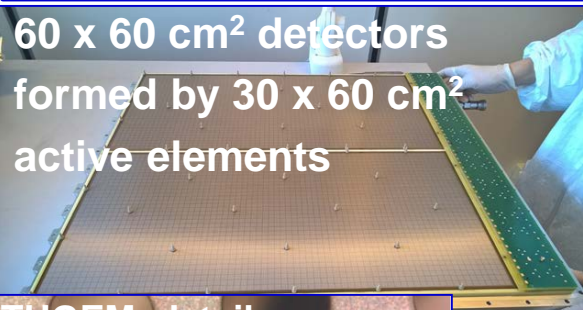
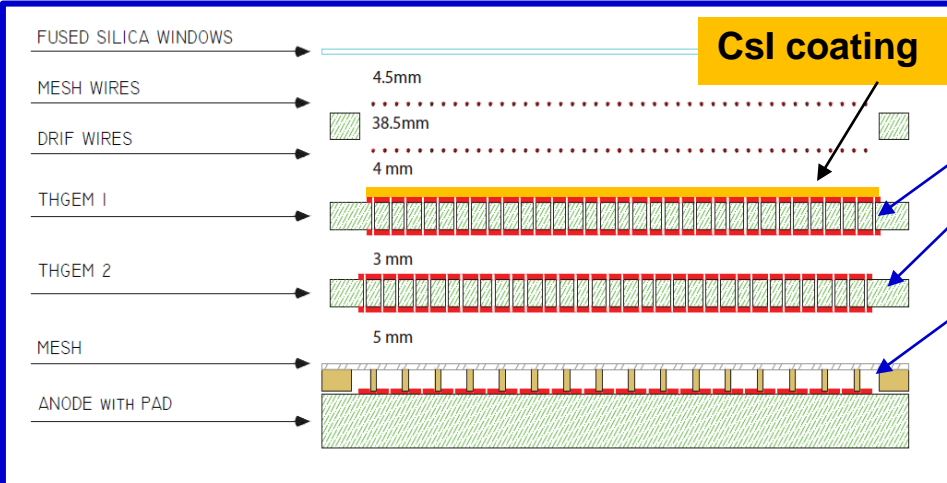
# DETECTOR ARCHITECTURE

**Following a 7-year R&D**

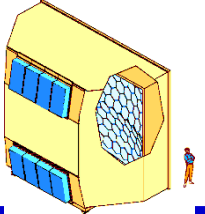
**THGEMs block photon feedback**

**Resistive MICROMEAS by bulk technology**

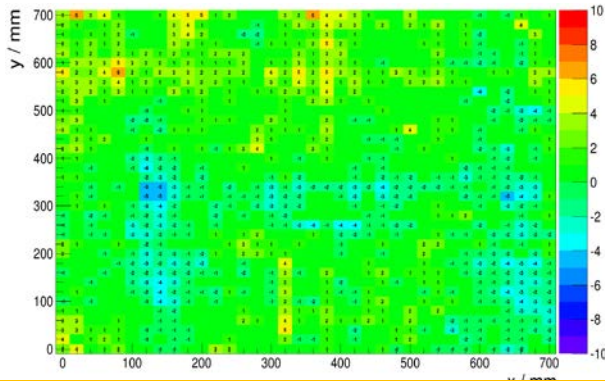
- traps the ions
- ~100 ns signal formation



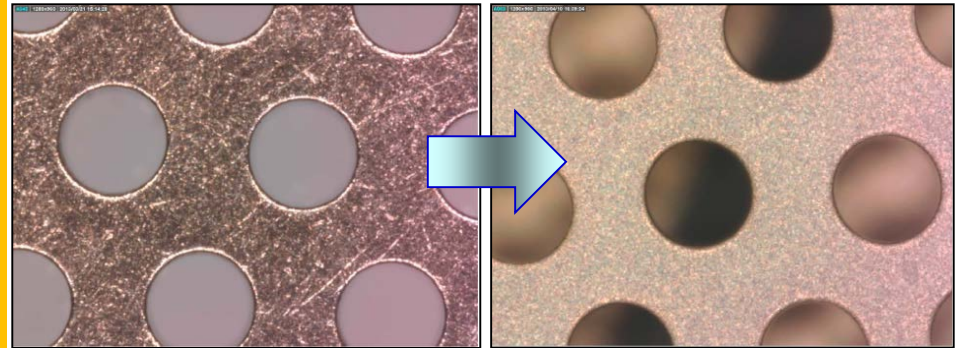
# COMPONENT QA in a nutshell



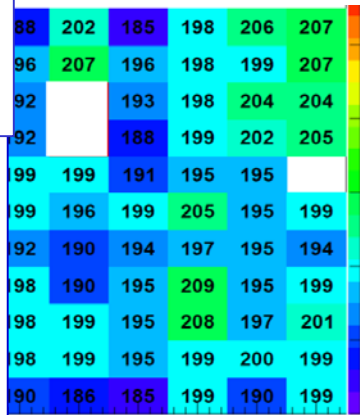
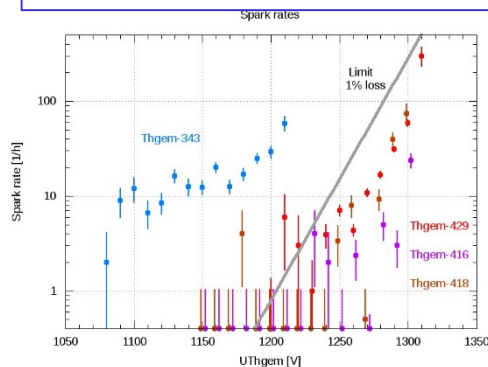
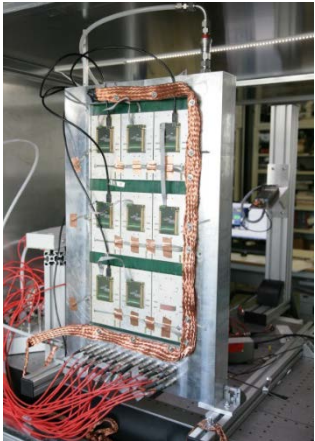
Measurement of the raw material thickness before the THGEM Production, accepted:  
 $\pm 15 \mu\text{m} \leftrightarrow$  gain uniformity  $\sigma < 7\%$



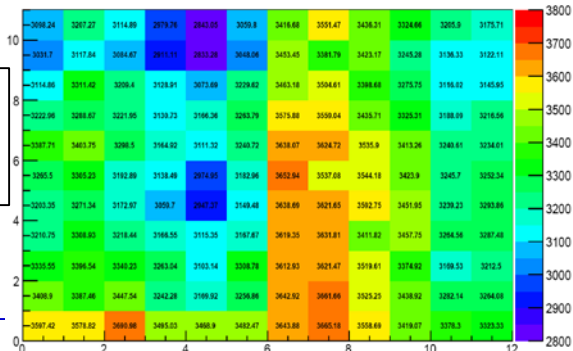
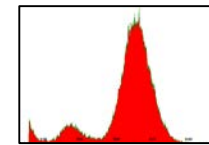
THGEM polishing with an “ad hoc” protocol setup by us:  
**>90% break-down limit obtained**



X-ray THGEM test to access gain uniformity (<7%) and spark behaviour

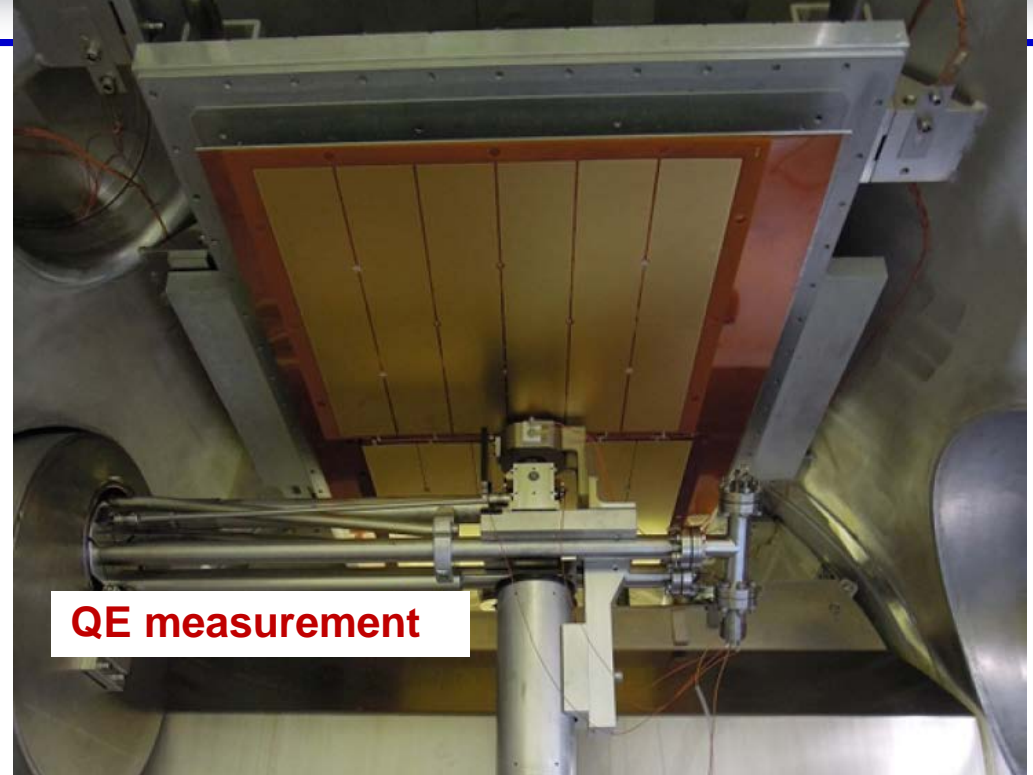
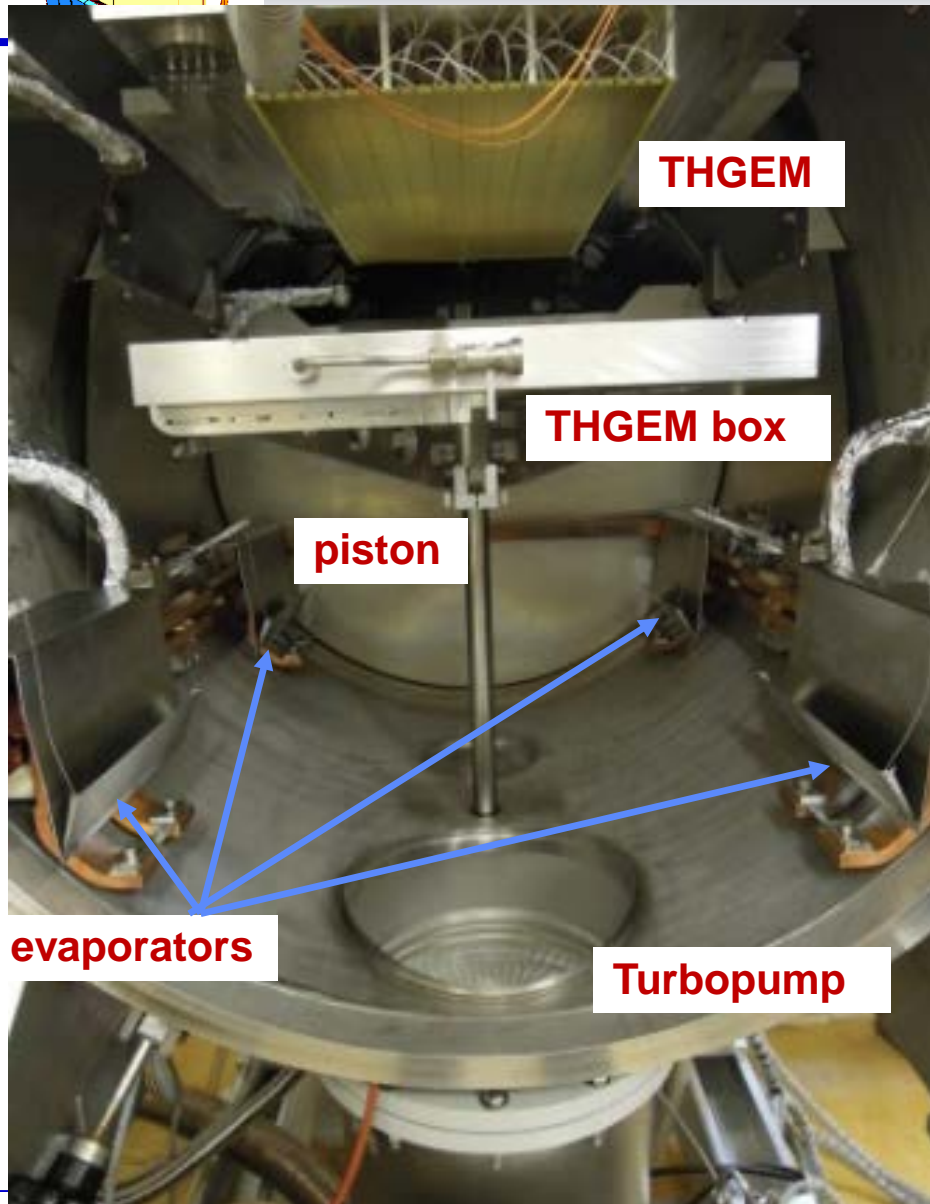
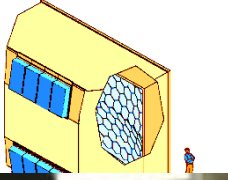


X-ray MM test to access integrity and gain uniformity (<5%)





# CsI coating for THGEMs

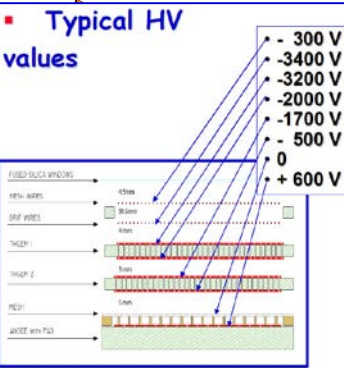
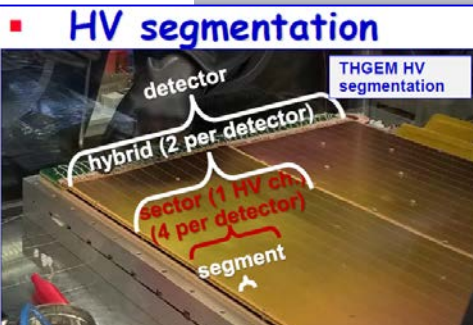


## QE uniformity

- 3 % r.m.s. within a photocathode
- 10 % r.m.s. among photocathodes
- **mean value: 93% of reference**

# HV CONTROL

**In total 136 HV channels with correlated values**



- Hardware, commercial by CAEN
- HV control
  - Custom-made (C++, wxWidgets)
  - Compliant with COMPASS DCS (slow control)
  - “OwnScale” to fine-tune for gain uniformity
  - V, I measured and logged at 1 Hz
  - Autodecrease HV if needed (too high spark-rate)
  - User interaction via GUI
  - Correction wrt P/T to preserve gain stability

- Gain stability vs P, T:
  - $G = G(V, T/P)$
  - Enhanced in a multistage detector
  - $\Delta T = 1^\circ\text{C} \rightarrow \Delta G \approx 12\%$
  - $\Delta P = 5 \text{ mbar} \rightarrow \Delta G \approx 18\%$
- THE WAY OUT:
  - Compensate T/P variations by V  
→ Gain stability at 5% level

HV Status

PD5				PD6			
O(R,F,D): 0, 0, 0 On: 0, Set: 104				O(R,F,D): 0, 0, 0 On: 0, Set: 104			
PD5S0	PD5S1	PD5S2	PD5S3	PD6S0	PD6S1	PD6S2	PD6S3
QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0
PD1S0	PD1S1	PD1S2	PD1S3	PD2S0	PD2S1	PD2S2	PD2S3
QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 100 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 100 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 104 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0	QIR: 0 QIF: 0 QID: 0 Set: 105 On: 0
PD1				PD2			
O(R,F,D): 0, 0, 0 On: 0, Set: 104				O(R,F,D): 0, 0, 0 On: 0, Set: 104			

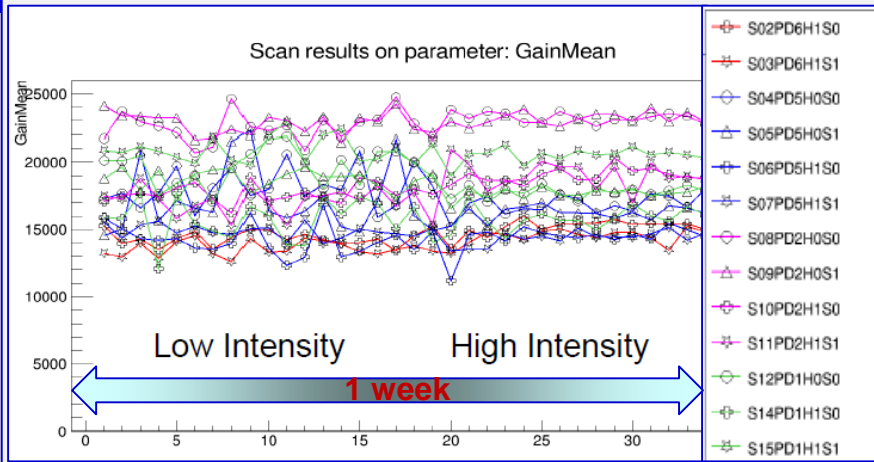
Sector Info

Change to Sector: PD1S1 [Select]

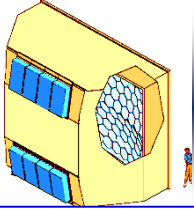
Name	Nom	OwnSc	SetSc	PTSc	Voltage	Electrode	VSet	VMon	IMon	NspR
EDrift	400	1.000	1.040	1.000	187.20	UDrift	3517.57	3517.34	0.000	0
UTngem1	1250	1.000	1.060	0.993	1316.01	UT1Top	3427.37	3426.67	0.000	0
ETrans1	1000	1.000	1.060	1.000	318.00	UT1Bot	2111.37	2111.06	0.004	0
UTngem2	1200	1.000	1.060	0.993	1263.37	UT2Top	1793.37	1793.07	0.001	0
ETrans2	1000	1.000	1.060	1.000	530.00	UT2Bot	530.00	529.96	0.001	0
UMesh	600	1.000	1.060	0.993	631.68	UMesh	631.68	631.79	2.628	0

CageDrift: 3517 V, 0.002 uA, 0 SpR      CageTop: 3330 V, 0.000 uA, 0 SpR      FieldWires: 0 V, 0.000 uA, 0 SpR  
 Status: OnState: 0, ScaleSet: 105%, QualityFactors: Recent: 0, Former: 0, Daily: 0

Regular updates [s]: [10] [?]      Update

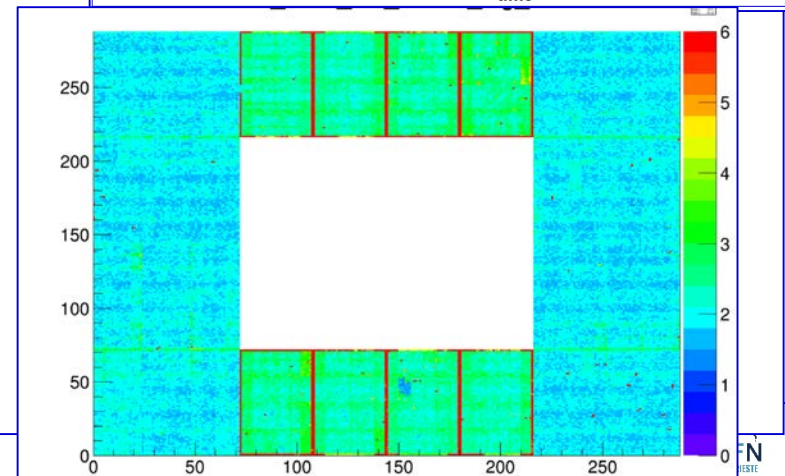
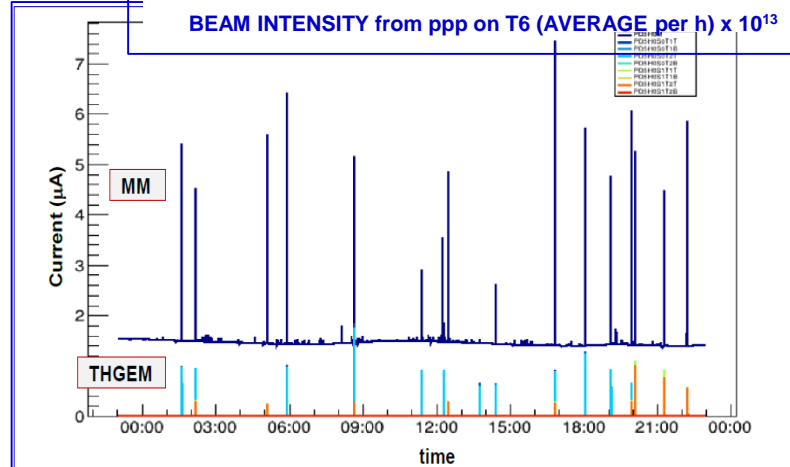
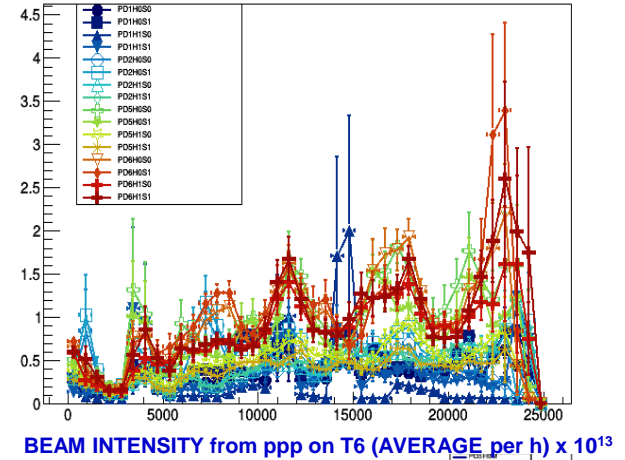


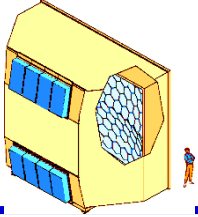




# MAIN DETECTOR FIGURES

- **Current sparks in THGEMs**
  - Rate < 1/h per detector
  - Recovery time: ~ 10 s
  - Fully correlated between the two layers
  - Mild dependence on beam intensity
  
- **Current sparks in MICROME GAS**
  - Induced by THGEMs
  - Recovery time: ~1 s
  
- **Ion backflow: ~ 3% level**
  
- **Noise: 900 electron equivalent (r.m.s.)**
  - Channel C : 4pF





# RINGS !!!

## Correlation between photons and trajectories

### From Event Display

- Ring centre calculated from particle trajectory
- Detected photoelectrons : hits on the sensors

For reference:

$$\theta (\beta = 1) = 52.5 \text{ mrad}$$

Ring centre (calc.)

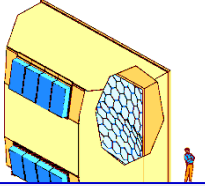
$$p = 3.5 \text{ GeV/c}$$
$$\theta = 34 \text{ mrad } (\pi \text{ hypothesis})$$

$$p = 3.8 \text{ GeV/c}$$
$$\theta = 38 \text{ mrad}$$

$$p = 4.8 \text{ GeV/c}$$
$$\theta = 43.5 \text{ mrad}$$

$$p = 7.8 \text{ GeV/c}$$
$$\theta = 49 \text{ mrad}$$

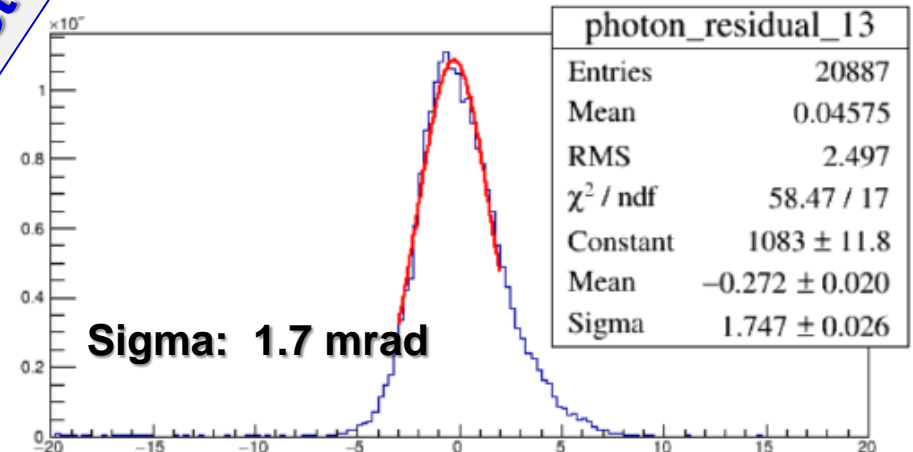
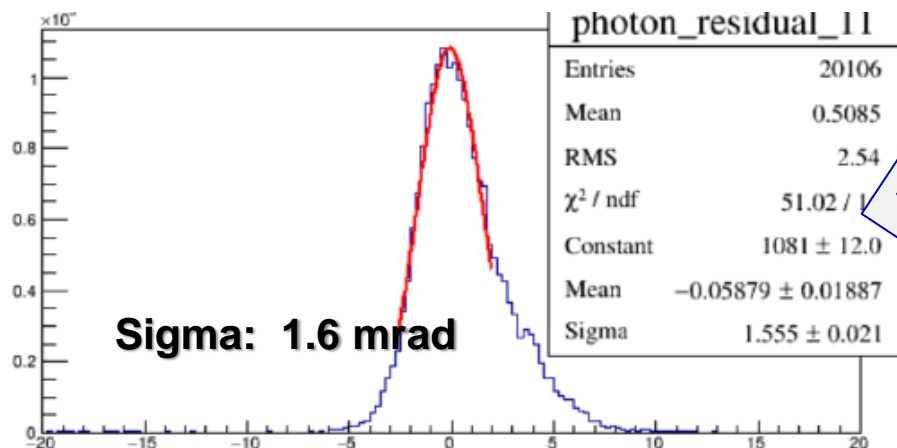
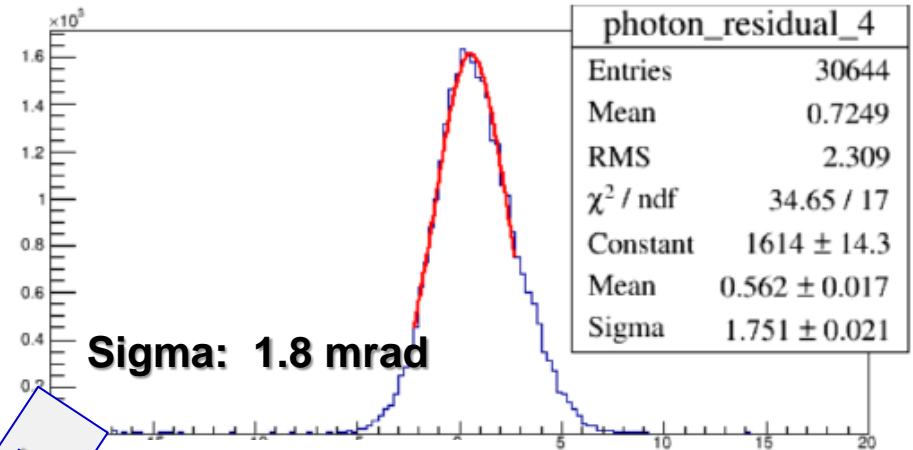
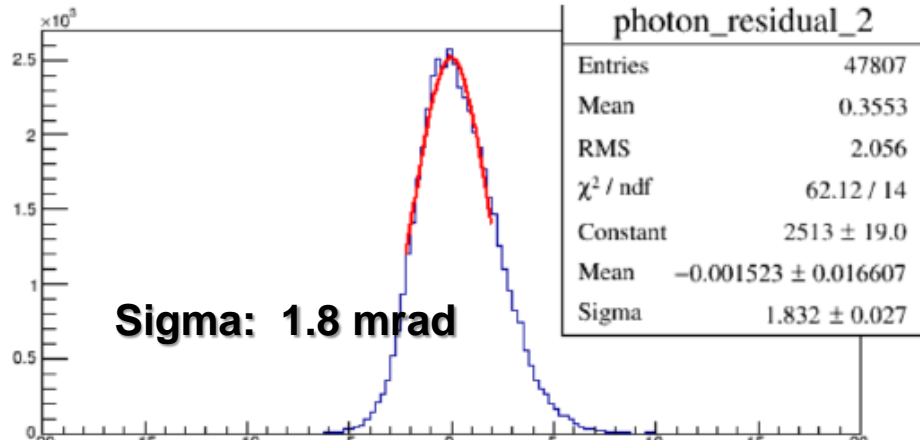
$$p = 8.4 \text{ GeV/c}$$
$$\theta = 49.5 \text{ mrad}$$



# INTRINSIC SPACE RESOLUTION

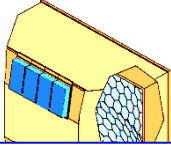
Residual distribution for individual photons (preliminary  $\pi$ -sample):

$$\theta_{\text{calculated}} - \theta_{\text{photon}}$$

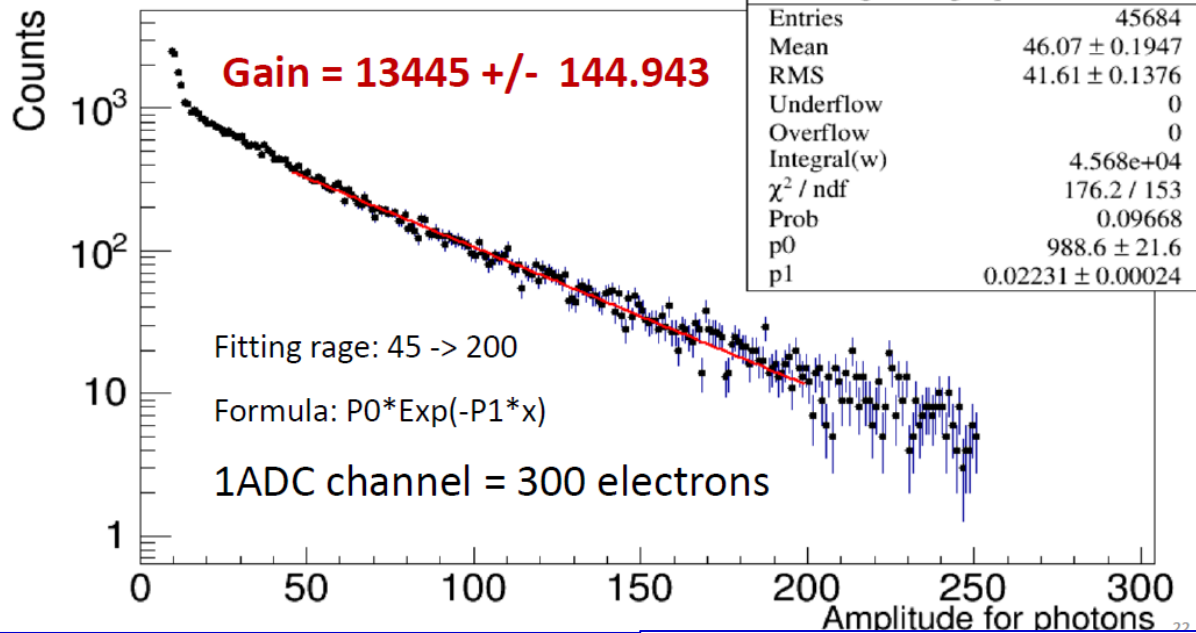


As expected





# GAIN FROM A PURE PHOTON SAMPLE



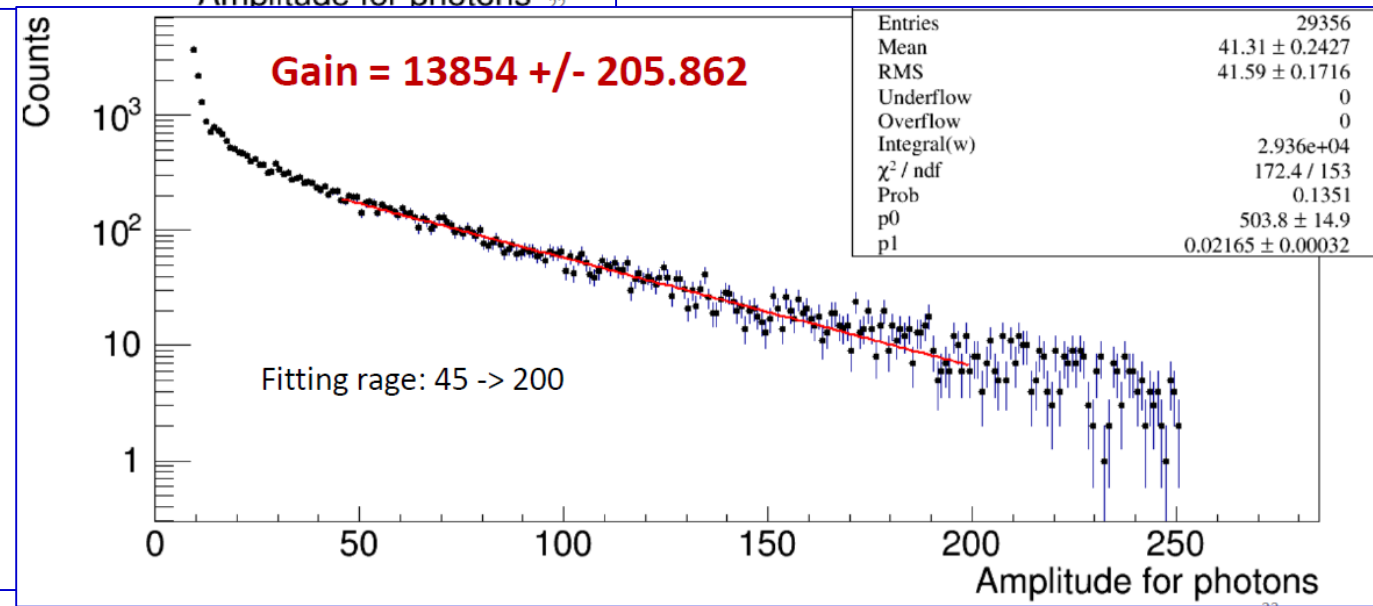
From electronic noise → Threshold

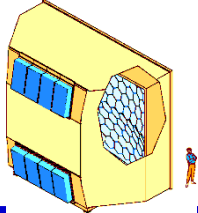
From threshold & gain → **photoelectron detection (effective) efficiency > 80%**

For comparison, in MWPCs: ~50-60%

from the extrapolated exponential an estimate of the **noise level under the signal:**

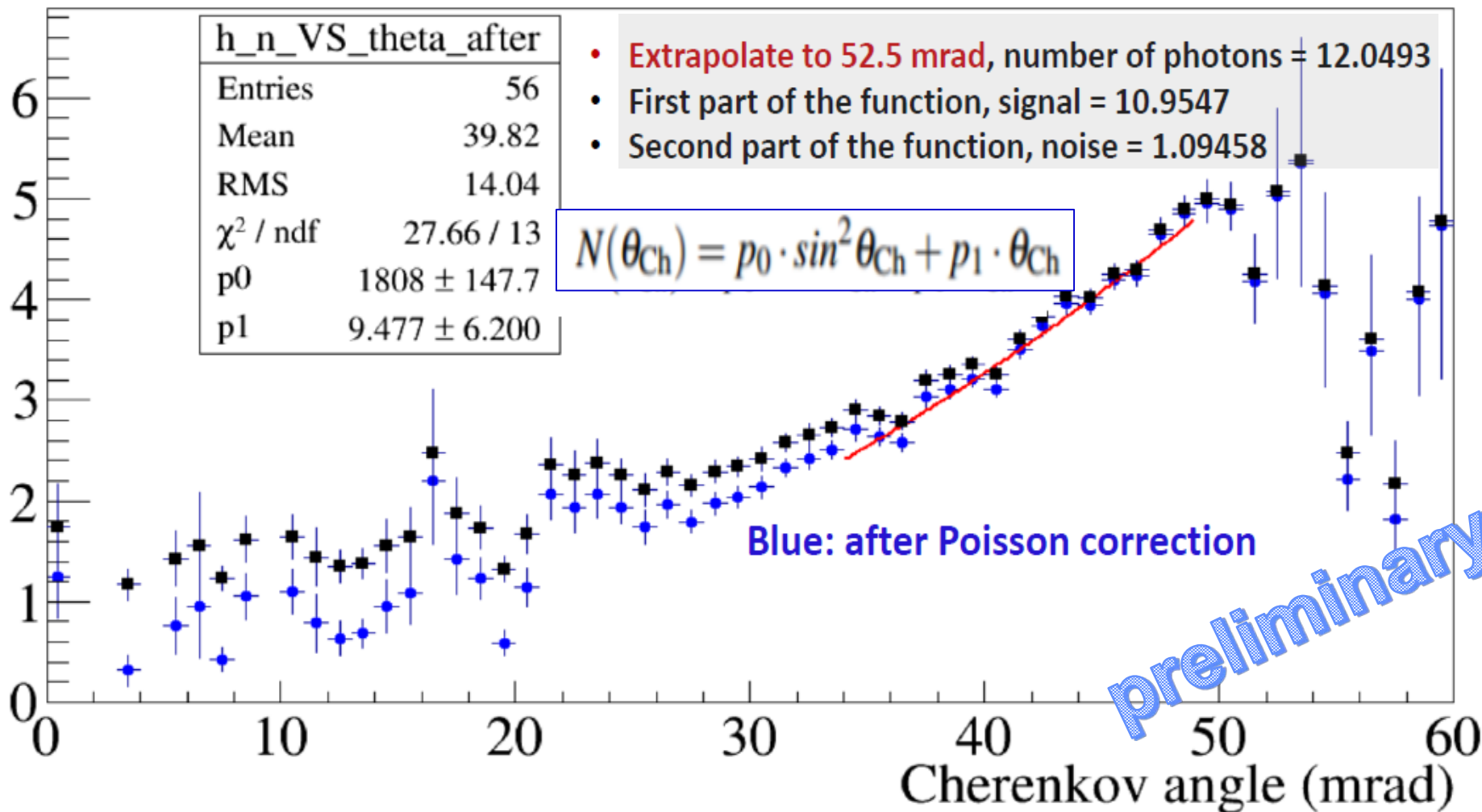
**~10%**

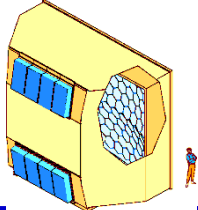




# DETECTED PHOTONS per RING

Number of Photons





# DETECTED PHOTONS per RING

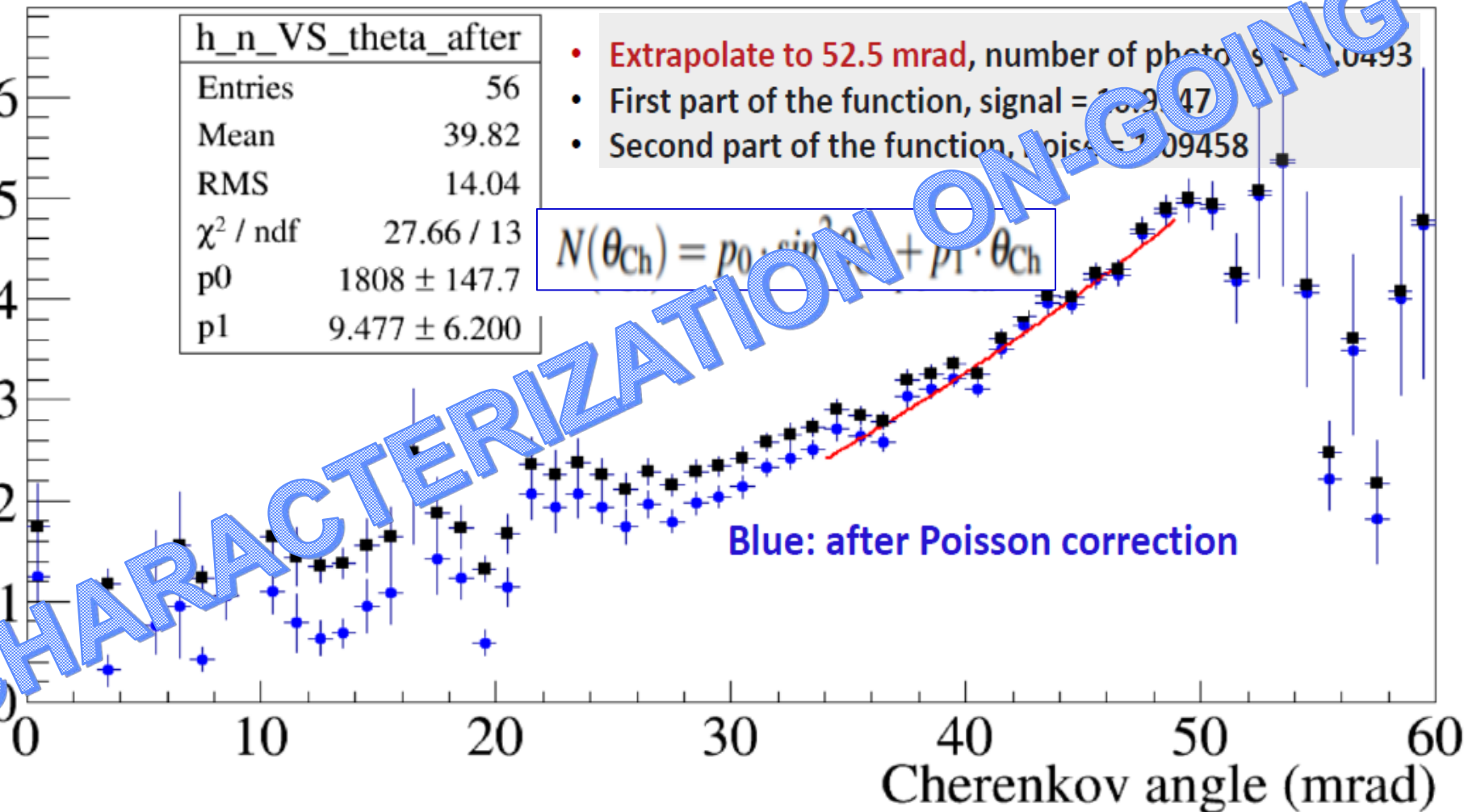
Number of Photons

h_n_VS_theta_after	
Entries	56
Mean	39.82
RMS	14.04
$\chi^2 / \text{ndf}$	27.66 / 13
p0	$1808 \pm 147.7$
p1	$9.477 \pm 6.200$

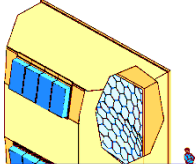
- Extrapolate to 52.5 mrad, number of photons = 1.0493
- First part of the function, signal = 1808.47
- Second part of the function, noise = 1.09458

$$N(\theta_{\text{Ch}}) = p_0 \cdot \sin^2 \theta_{\text{Ch}} + p_1 \cdot \theta_{\text{Ch}}$$

Blue: after Poisson correction





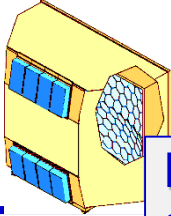


# PERSPECTIVES OF h-PID @ HIGH p

## h-PID at high p ( $> 6-8 \text{ GeV}/c$ )

- Required for physics at the future **ELECTRON-ION COLLIDER (EIC)**
- Collider-specific issues
  - shorter radiator to control setup sizes (advantages also for fixed target)  
namely more detected photons per unit radiator length  
→ increased resolution
  - Operation in magnetic field
- An interesting option
  - Exploit the extremely far VUV region ( $\sim 120 \text{ nm}$ ) with a windowless RICH and gaseous photon detectors, test beam @ Fermilab

IEEE NS 62 (2015) 3256



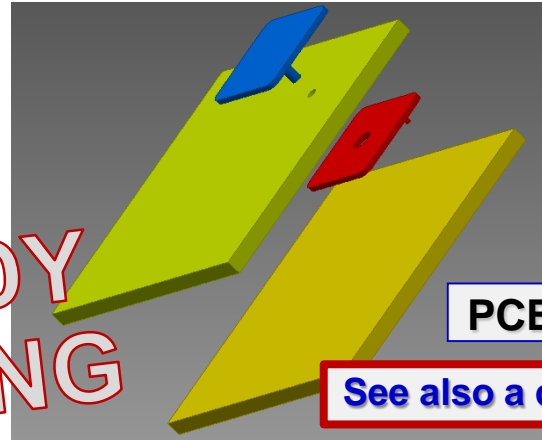
# MOVING FURTHER WITH MPGD-based PDs

In the frame of

- Generic R&D for EIC – eRD6
- INFN – RD\_FA

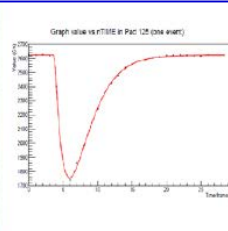
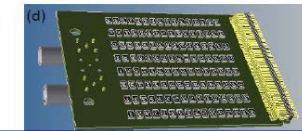
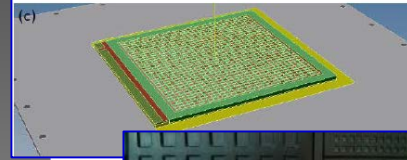
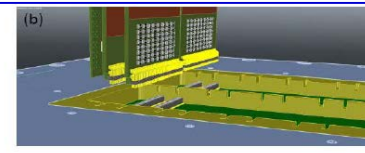
resistive MM  
with **small**  
**pad size**  
 $O(10 \text{ mm}^2)$

**ALREADY  
ON GOING**

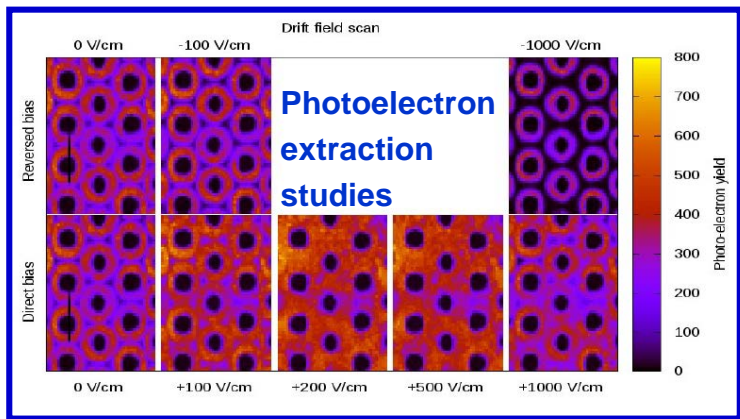


PCB

See also a dedicated poster by J. Agarwala

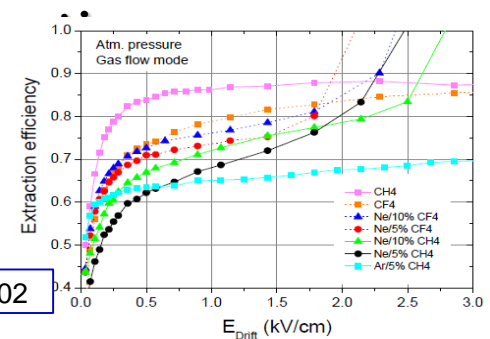


## GEM vs THGEM as photocathodes

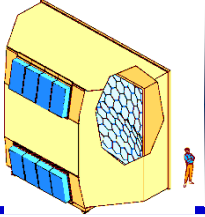


## Issues related to hybrid MPGD-based PDs operated in C-F atmosphere:

- photoelectron extr
- detector gain
- ageing



C. D. R. Azevedo et al., 2010 JINST 5 P01002



# A VERY RECENT NEW OPTION FOR THE R&D

**CsI, the only standard photoconverter compatible with gaseous atmospheres, has problematic issues, main ones:**

- It does not tolerate exposure to air ( $H_2O$  vapour,  $O_2$ )
- Ageing by ion bombardment

**Antonio Valentini et al. – INFN Bari**

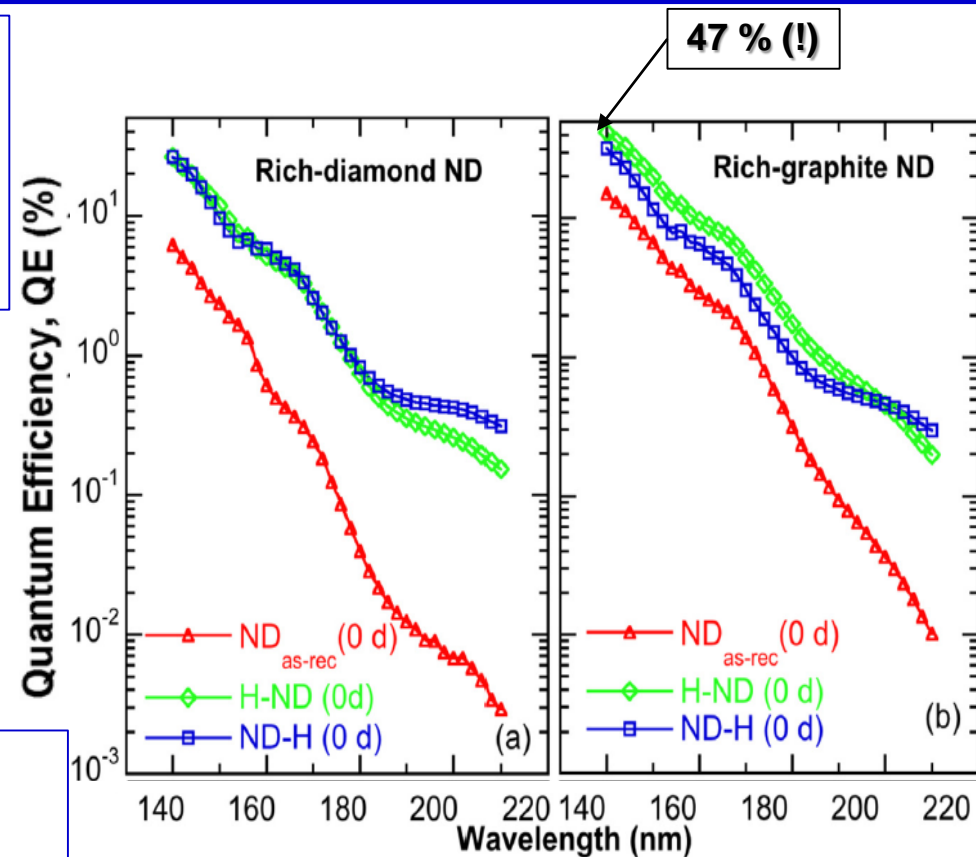
**Italian patent application n. 102015000053374**

- **Photocathodes: diamond film obtained with Spray Technique** making use of hydrogenized ND powder
  - Spray technique:  $T \sim 120^\circ$  (instead of  $>800^\circ$  as in standard techniques)

**Coupling of ND photoconverter and MPGDs?**

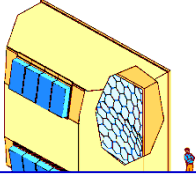
**an exiting perspective with several open questions**

- **Compatibility, performance with gas ?**
- **Radiation hardness ?**
- **Ageing ?**



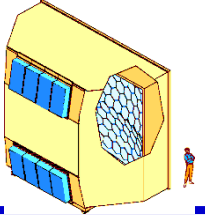
L.Velardi, A.Valentini, G.Cicala al.,  
Diamond & Related Materials 76 (2017) 1



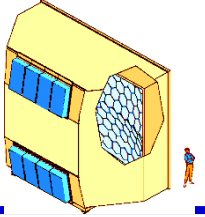


# SUMMARIZING ...

- **MPGD-based photon detectors ACCOMPLISH THEIR MISSION in COMPASS RICH-1**
  - From preliminary characterization exercises:  
stable gain, large gain, good number of detected photoelectrons
- **Technological achievement - for the FIRST TIME:**
  - single photon detection is accomplished by MPGDs
  - THGEMs used in an experiment
  - MPGD gain  $> 10k$  in an experiment
- **MPGD-based photon detectors have a mission in the future of hadron physics**



THANK YOU



# MORE INFORMATION

# HANDLING THE VUV DOMAIN

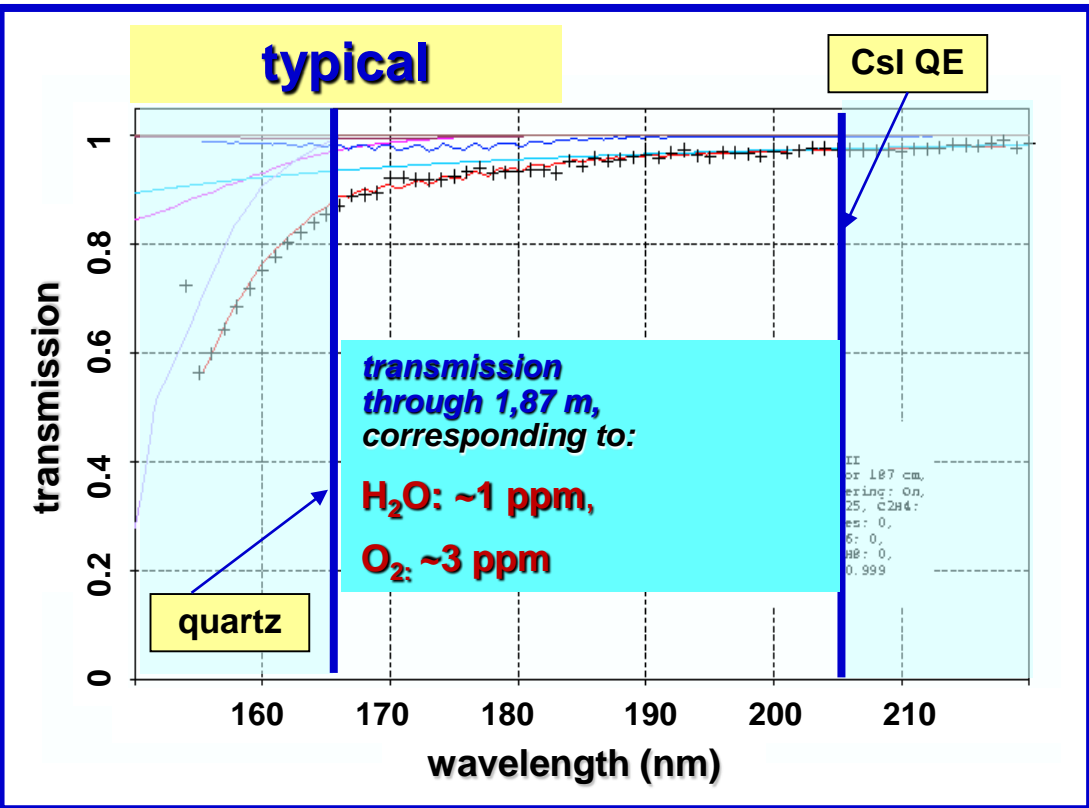
## CsI gasous sensors used in several Cherenkov detectors

MWPCs with solid state photocathode (the RD26 effort)

A solid state photocathode exposed to a gaseous atmosphere in an effective PD: a success!

## COMPASS RICH-1, gas transparency

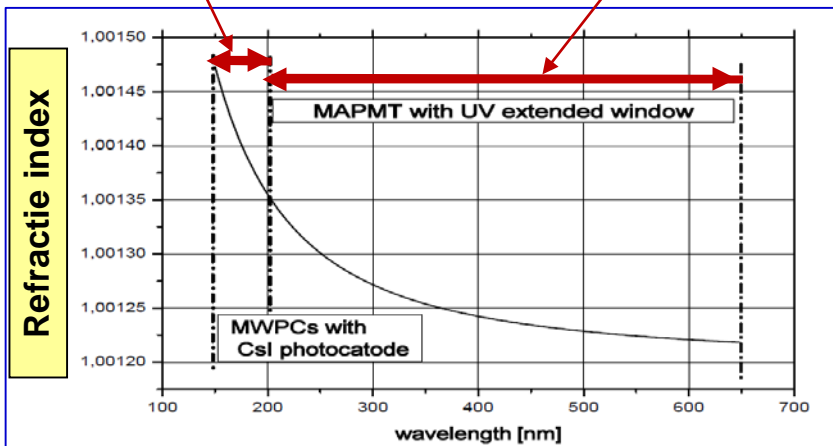
- gas cleaning by on-line filters,
- separate functions:
  - Cu catalyst,  $\sim 40^\circ\text{C}$  for  $\text{O}_2$
  - 5A molecular sieve,  $\sim 10^\circ\text{C}$  for  $\text{H}_2\text{O}$



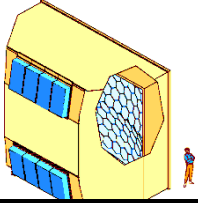
$(n-1)$  r.m.s (assuming Frank and Tamm):

$30 \times 10^{-6}$

$46 \times 10^{-6}$







# OUR THGEM DESIGN

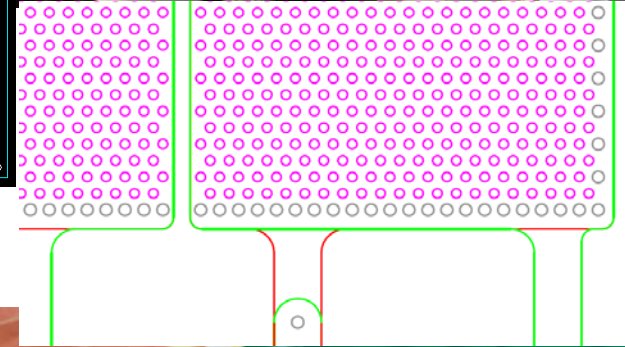
Thickness: 0.4 mm, hole diameter: 0.4 mm, pitch: 0.8 mm

12 sectors on both top and bottom, 0.7 mm separation

24 fixation points to guarantee THGEMs flatness

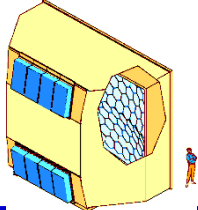


two THGEMs side by side to form the 60 x 60 cm<sup>2</sup> surface



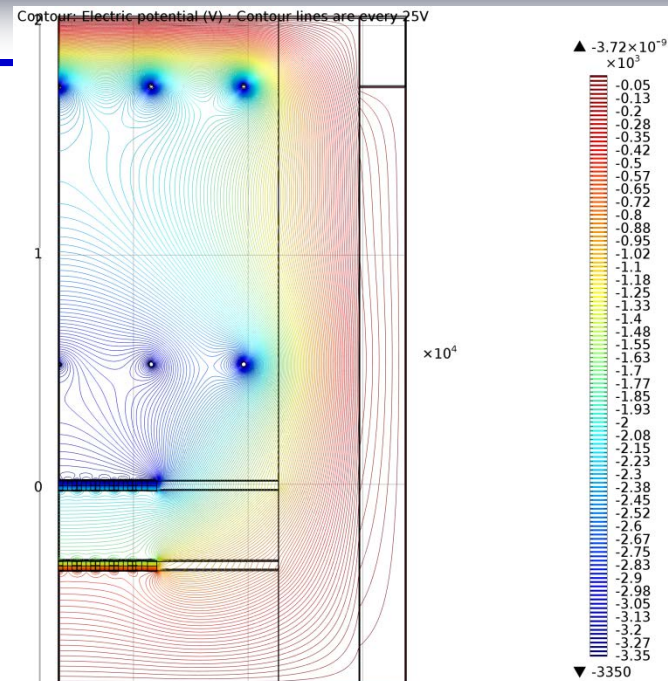
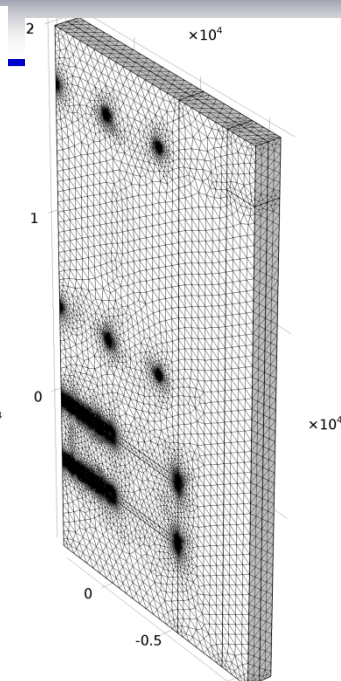
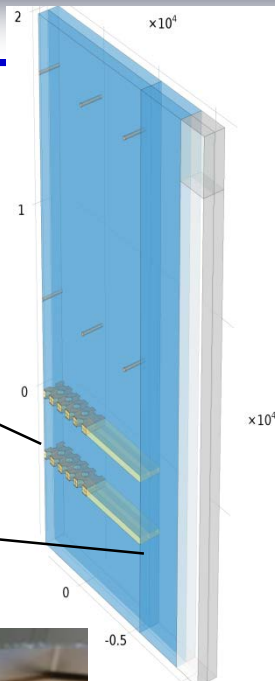
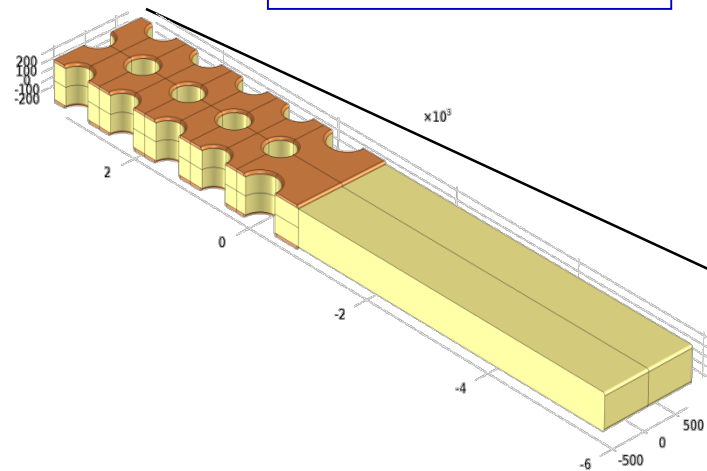
border holes diam.: 0.5 mm

pillars in PEEK

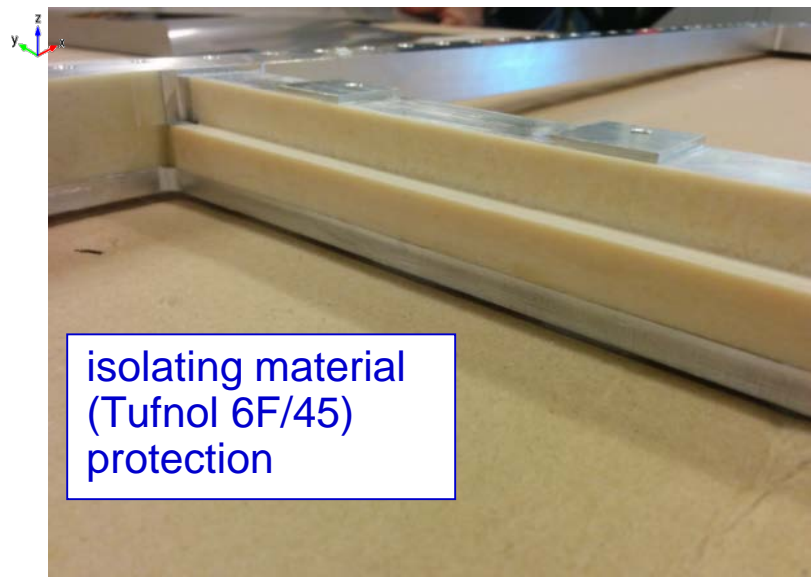


# FIELD SHAPING ELECTRODES AT THE EDGES

THGEM border study

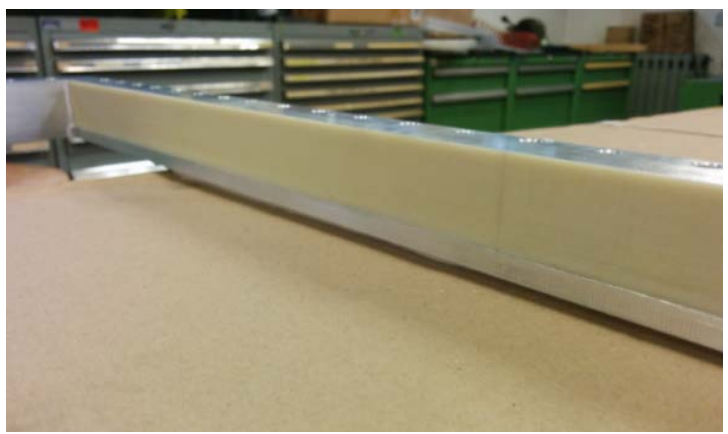


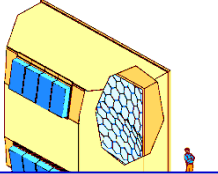
large field values at the chamber edges and on the guard wires



isolating material (Tufnol 6F/45) protection

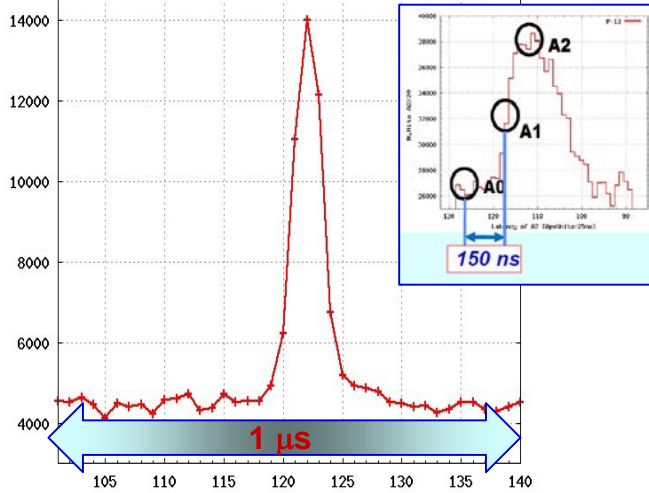
Field shaping electrodes in the isolating material protections of the chamber frames





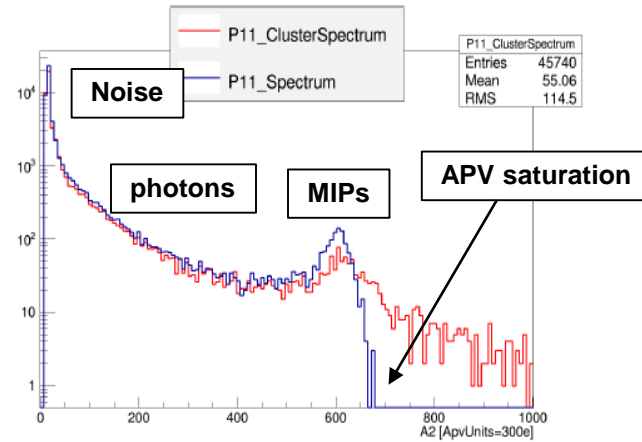
# THE PHOTOELECTRON SIGNAL

**Selecting good hit candidates**  
( $A0 < 5$  ADC units,  $0.2 < A1/A2 < 0.8$ )

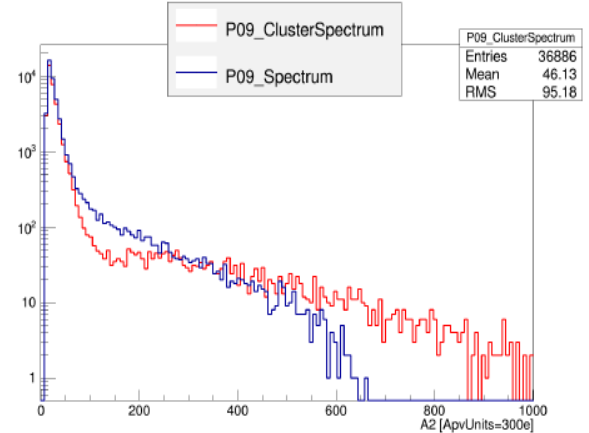


**Clusterization to separate MIPs**

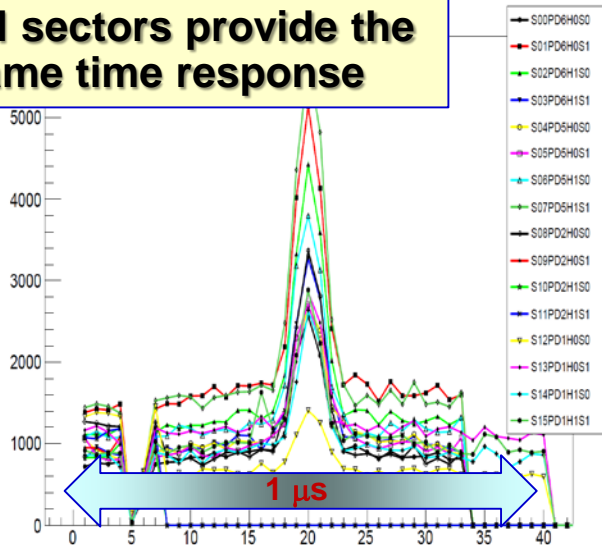
**Hybrid MPGD (novel detector)**



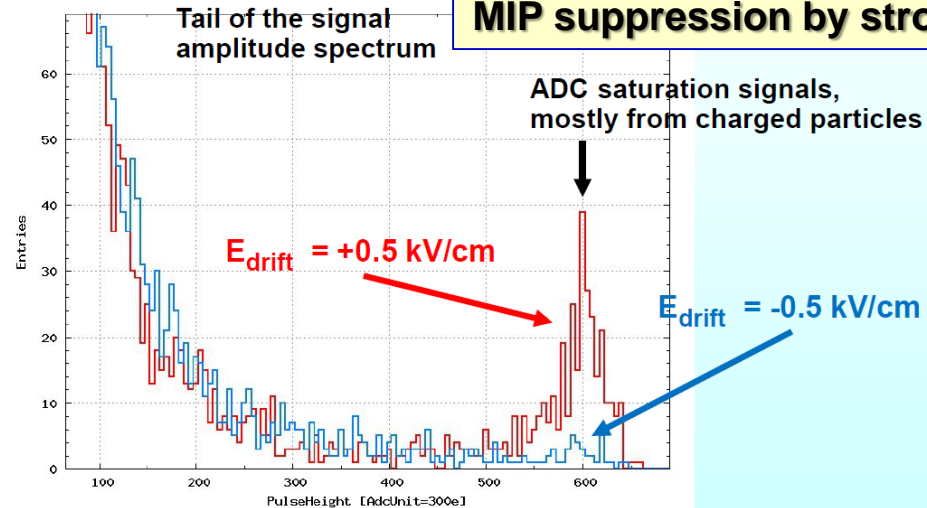
**MWPC (old detector)**



**All sectors provide the same time response**

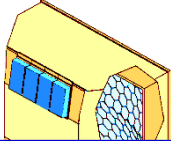


**Tail of the signal amplitude spectrum**



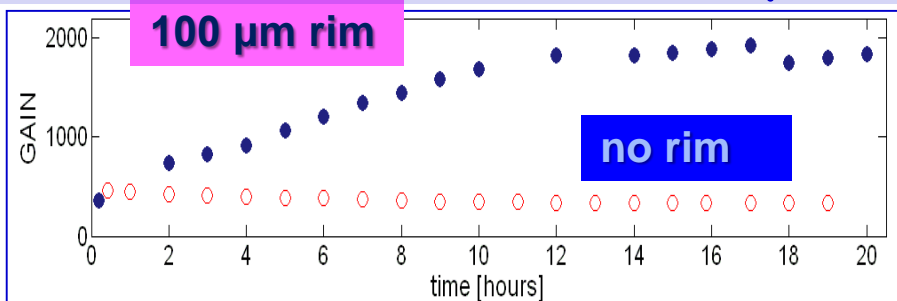
**MIP suppression by strong reversed bias**



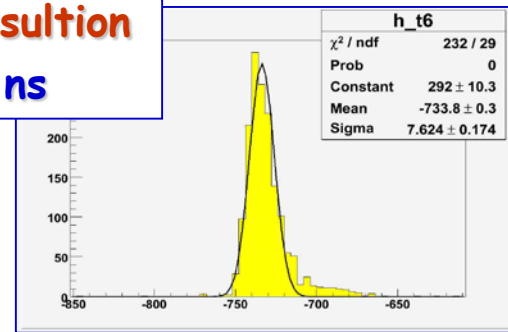


# After 7 years of R&D

## THGEM characterization, performance

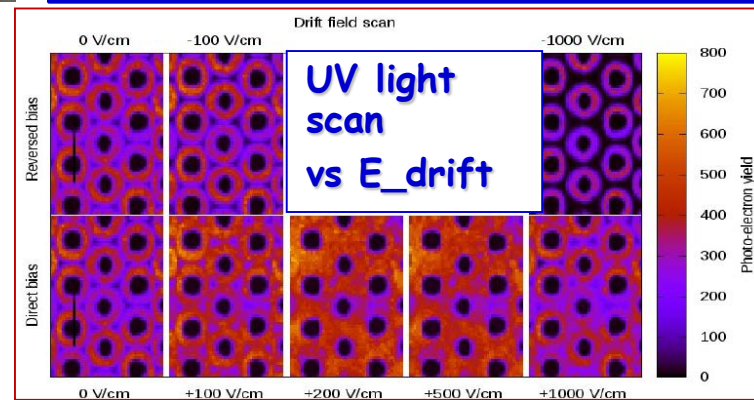
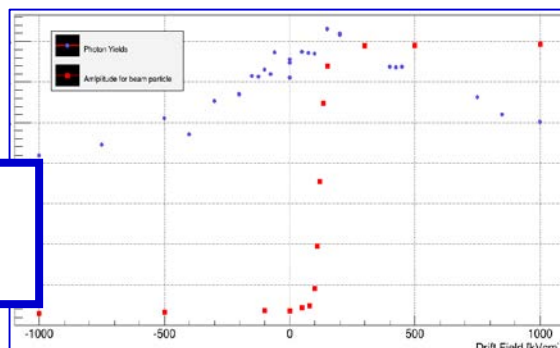


**Time resolution**  
~7 ns



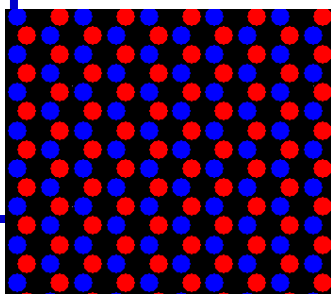
## Photoelectron extraction

**Photon yield (blue)**  
& **Charged Particles (red)**  
vs **Drift Field**



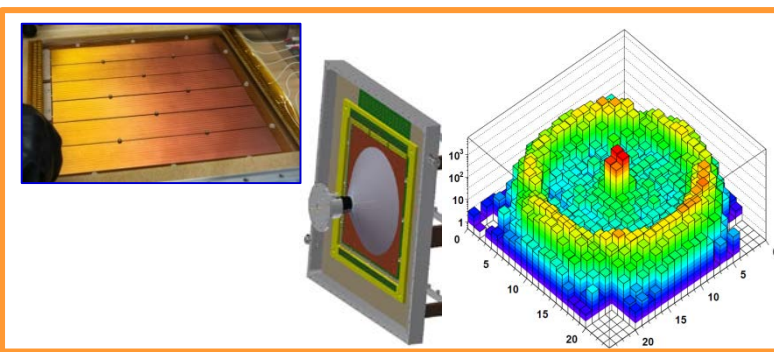
## IBF (Ion Back Flow) suppression

**Tripple THGEM:**  
IBF suppression (<5%) by staggering plates

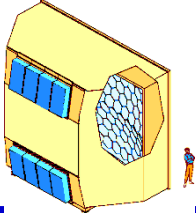


IBF suppression (<3%) introducing a MM stage:  
no need of high Transfer electric field  
→ **Hybrid architecture**

## Cherenkov light detection in TB



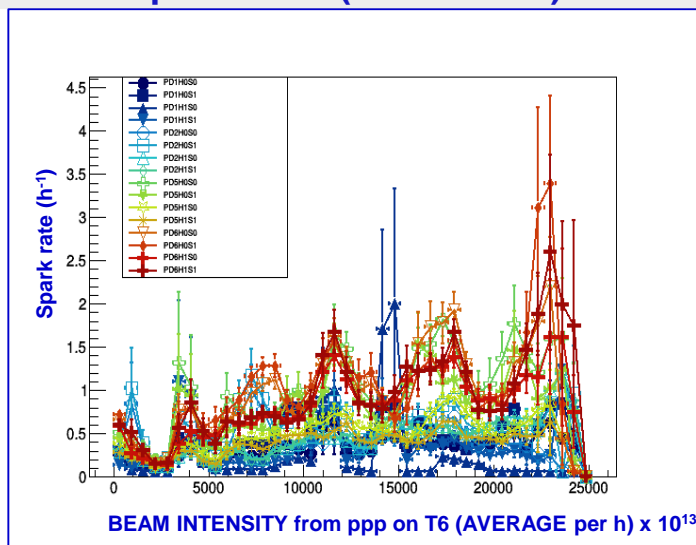




# ELECTRICAL STABILITY

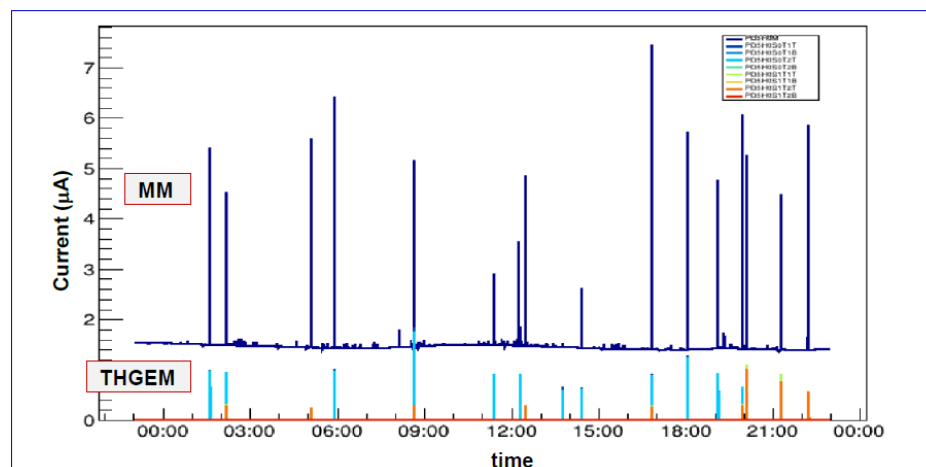
## THGEMs, lessons

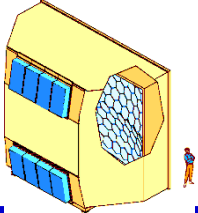
- Full vertical correlation of current sparks THGEM1 & THGEM2
- Recovery time <10 s (our HV arrangement)
- Spark rates: ~ no dependence on beam intensity and even beam on-off
- Discharge correlation within a THGEM (also non adjacent segments) and among different THGEMs (cosmics ?)
- Total spark rates (4 detectors): ~10/h



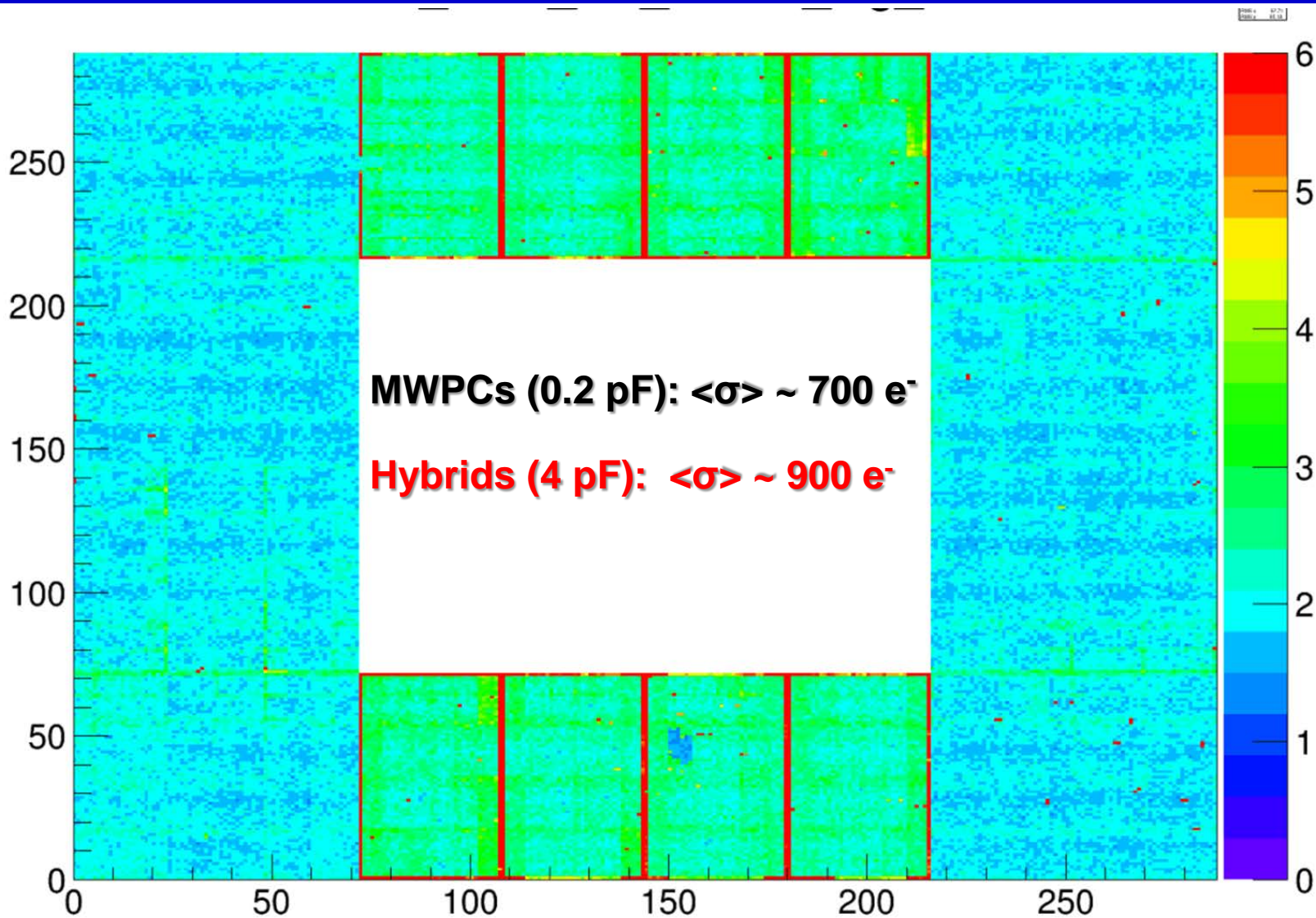
## MICROMEAS, lessons

- MM sparks only when a THGEM spark is observed (not vice versa)
- Recovery time ~1s (our HV arrangement)
- The only real issue: dying channels (pads)
  - Local shorts, larger current, no noise issue
  - 2.5 ‰ developed in 12 months
  - Dirty gas / dust from molecular sieves & catalyst?

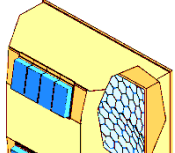




# NOISE FIGURES



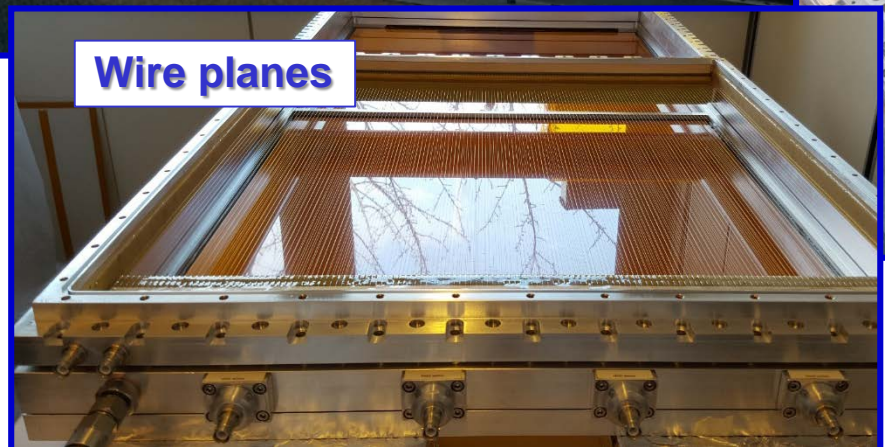
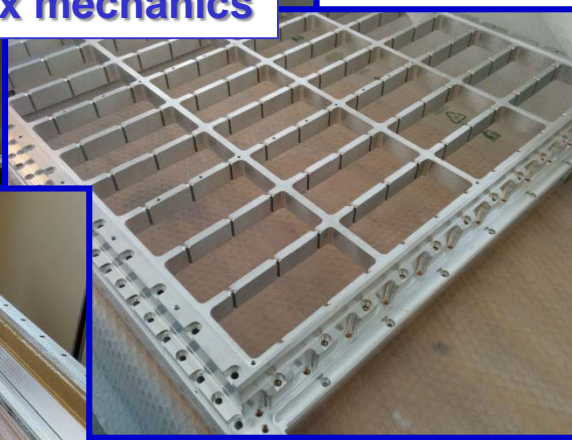




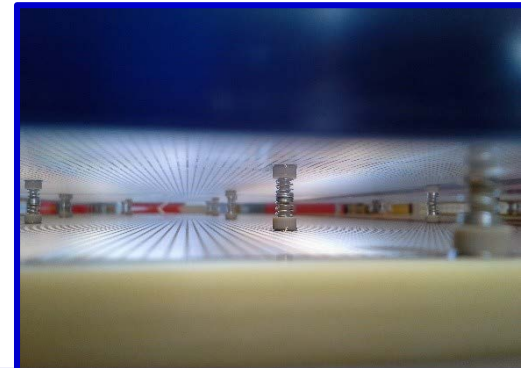
# CONSTRUCTION & ASSEMBLY



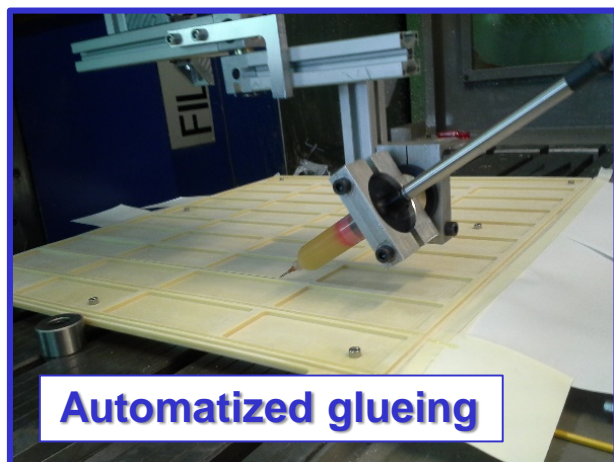
**Complex mechanics**



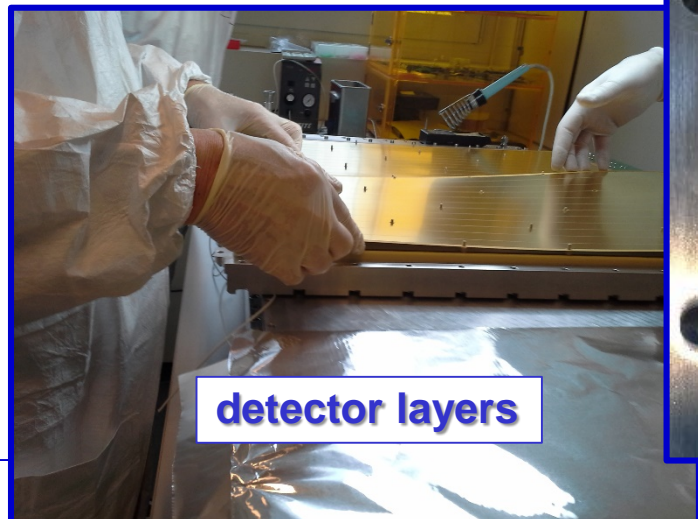
**Wire planes**



**Glueing the support pillars**



**Automatized glueing**

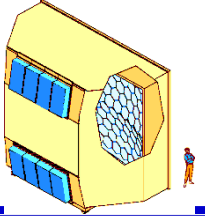


**detector layers**



**THGEM staggering**





# ASSEMBLY in a nutshell

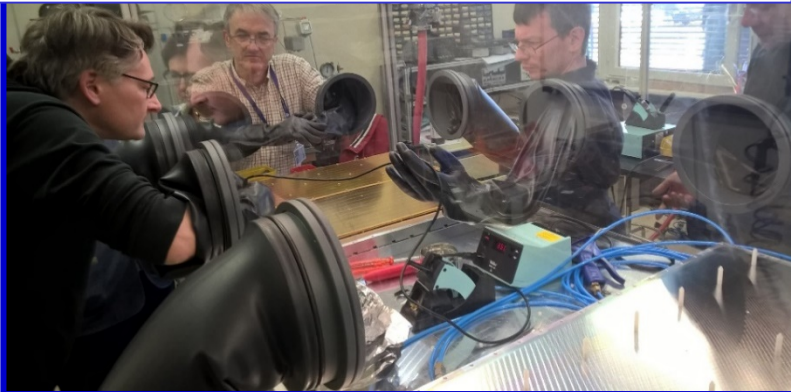


Pre-assembly w/o Csl

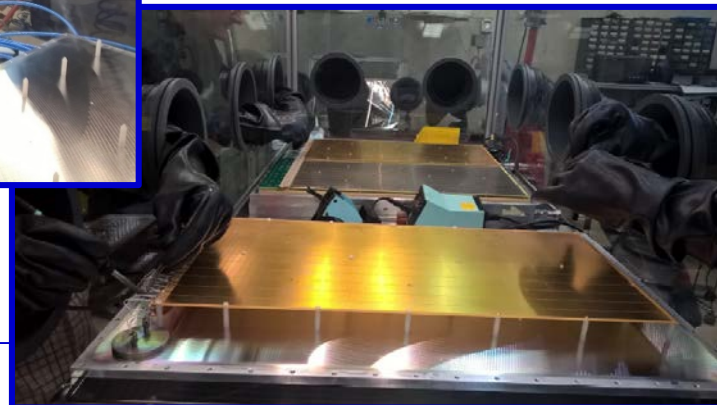


Onto the RICH

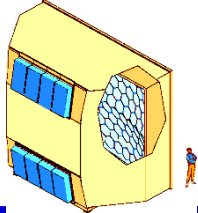
final assembly of the active module assembly with Csl in glovebox



glovebox also to mount the active module onto the RICH







# CsI QE measurements at coating

19 CsI evaporations performed in 2015 - 2016  
 on 15 pieces: 13 THGEMs, 1 dummy THGEM,  
 and 1 reference piece (best from previous coatings)

11 coated THGEMs available, 8 used + 3 spares

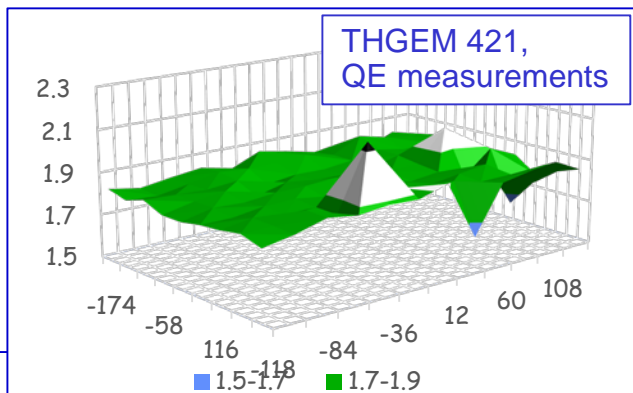
THGEM number	evaporation date	at 60 degrees	at 25 degrees
Thick GEM 319	1/18/2016	2.36	2.44
Thick GEM 307	1/25/2016	2.65	2.47
Thick GEM 407	2/2/2016	2.14	2.47
Thick GEM 418	2/8/2016	2.79	2.98
Thick GEM 410	2/15/2016	2.86	3.14
Thick GEM 429	2/22/2016	2.75	2.74
Thick GEM 334	2/29/2016	2.77	3.00
Thick GEM 421 re-coating	3/10/2016	2.61	2.83
Reference piece	7/4/2016	3.98	3.76

$$I_{Normalized} = \frac{I_{CsI} - I_{CsI_{Noise}}}{I_{Ref} - I_{Ref_{Noise}}}$$

QE measurements indicate

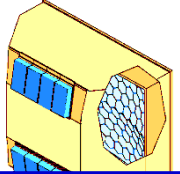
$\langle \text{THGEM QE} \rangle =$   
**0.73 x Ref. piece QE**  
 with s.r.m. of 10%

in agreement with expectations  
 (THGEM optical opacity = 0.78)



QE is the result of a surface scan  
 (12 x 9 grid, 108 measurements)

Good uniformity, in the example  $\sigma_{QE} / \langle \text{QE} \rangle = 3\%$



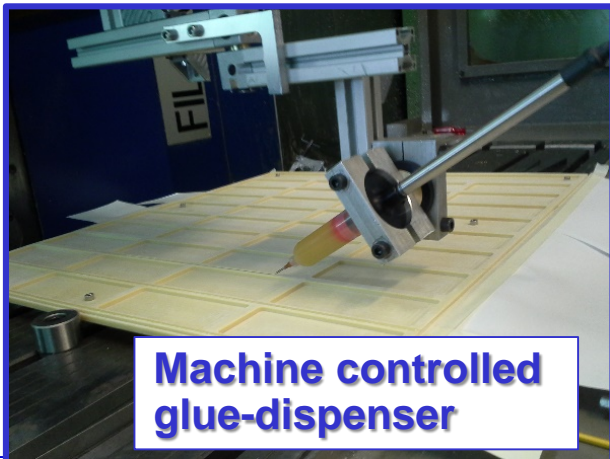
# CONSTRUCTION & ASSEMBLY



**Complex and precise mechanics**



**Assembly in clean room**



**Machine controlled glue-dispenser**

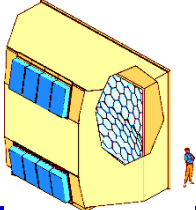


**Including photocathode in glovebox**

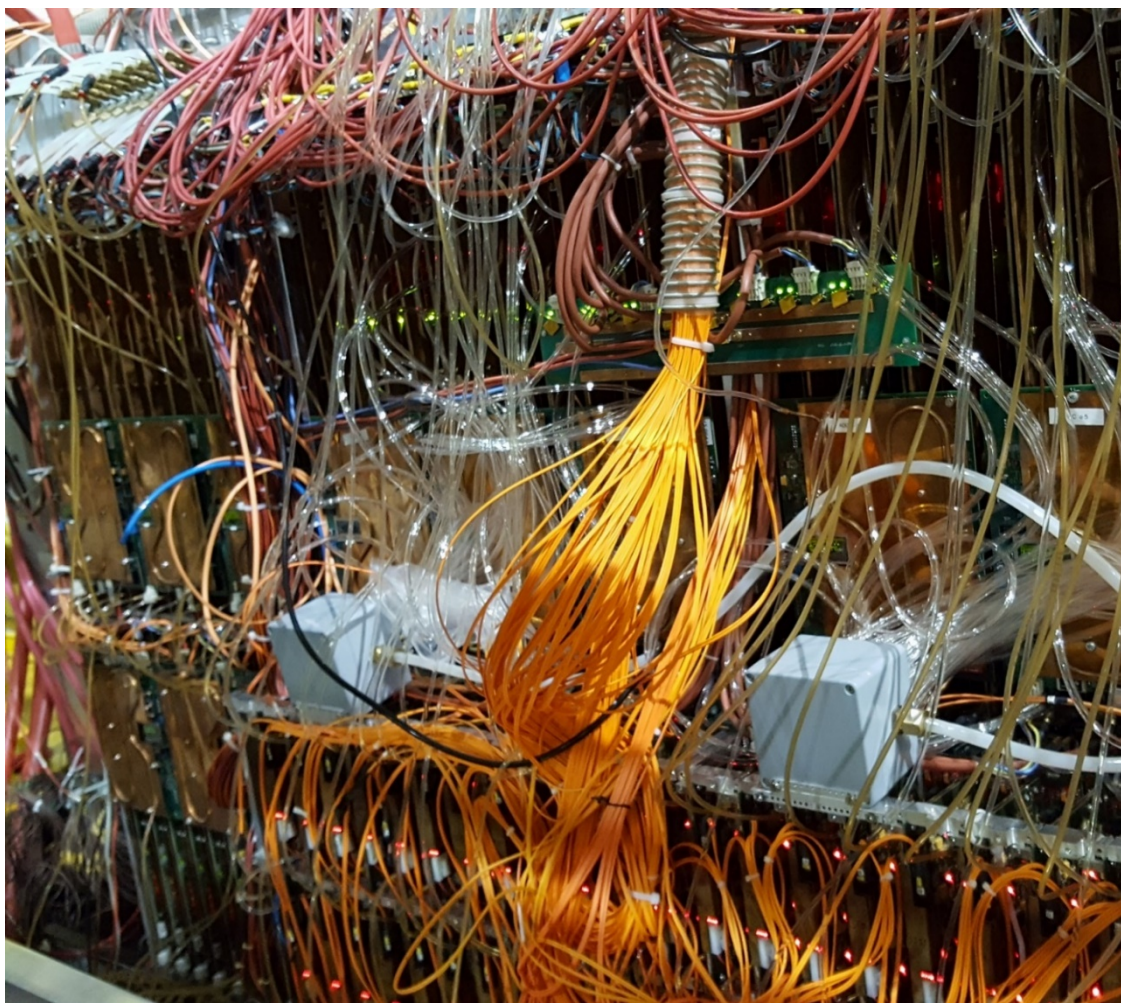


**glovebox also to mount the active module onto the RICH**



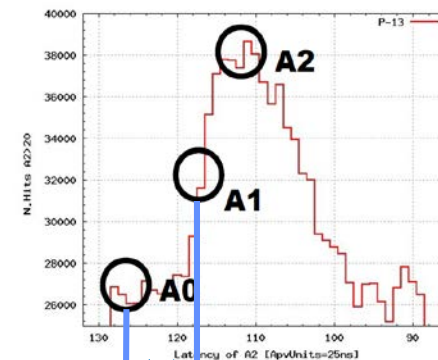


# READ-OUT and SERVICES



read-out :  
already available for the MWPCs with CsI

**FE chip APV25**



**150 ns**

**LV supply**

**COOLING**

**Gas lines**

**P, T sensors**